

(Sr.) Process Integration Engineer (m/f/d) - SiC

What you will do

- Develop new wafer process modules for SiC wafers (doping, Laser anneal, CVD, etching, cleaning, characterization)
- Execute major process development or integration tasks and build up product and process knowledge
- Leader of small or medium size process integration or optimization projects
- Sub-project leader of process development or integration tasks in complex projects
- Build up and maintain knowledge (technical & procedures) and BG internal & external contacts in own field of expertise
- Active member in PC&O Process improvement teams
- Provide technical mentorship to less experienced engineers

What you will need

- Master's degree in Semiconductor Device Physics or Semiconductor Technology and/or Microelectronics
- Minimum 3 years' relevant working experience
- Knowledge of semiconductor devices and industrial semiconductor technology
- Hands on experience in wafer fab process module developments on furnace equipment
- Team player with a strong drive to achieve success
- Fluency in German. Good level in English
- Willingness to travel internationally (approximately 50% during the first 2 years of service)
- Good communication skills, both verbal and in writing

More information?

For more details please contact: john.perez@nexperia.com

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Location

Hamburg

Employment type

Fulltime

Contract duration

Permanent

Job-id

R-20007276



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